



Heat load review Methodology

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<https://indico.cern.ch/event/1019569/>

EDMS 2560556

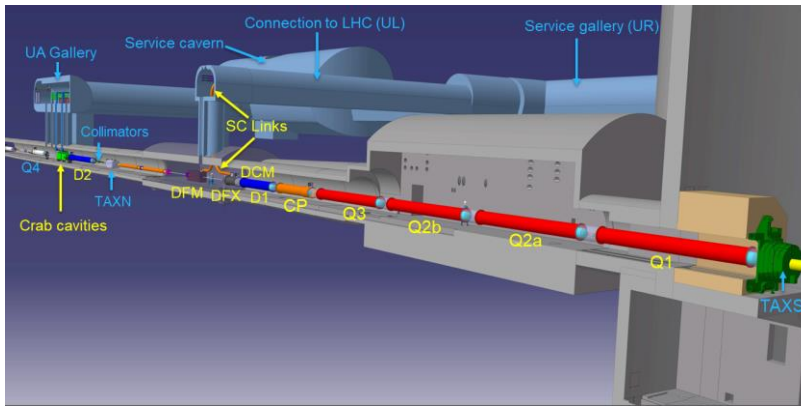
CERN, 27/04/2021



Content

- Introduction and Terminology
 - Hilumi machine configuration
 - Heat load classification and deposition
 - Design coefficients
- Hilumi heat load methodology
 - Static
 - Dynamic
 - Heat load database
- Conclusions
- Overview

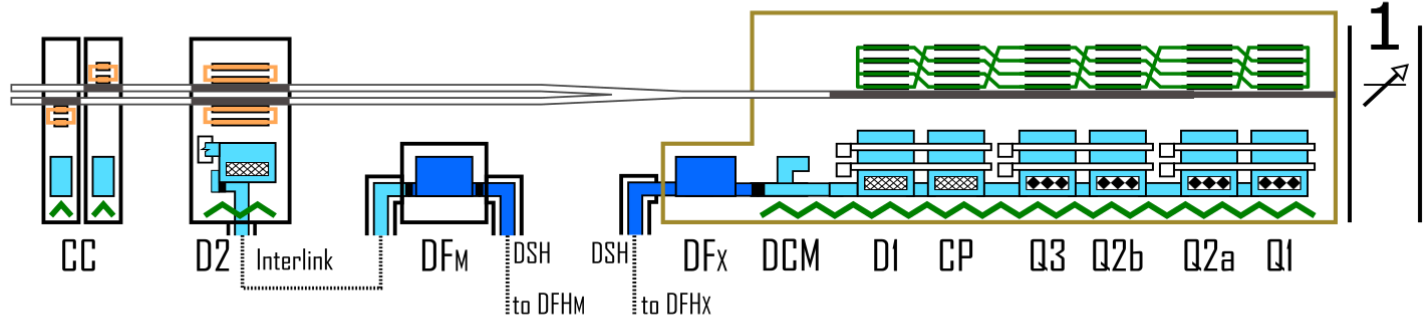
Hilumi Machine configuration P1/P5



The **variety** of Users/ Components required a **homogeneous and systematic methodology** to guide towards the design of Refrigerator.

Beam Screen

Cold Mass
Thermal Shield



Thermal Shield
temperature

60-80 K

Beam Screen
temperature

60-80 K

4.5-20 K

Cold Mass
temperature

4.5 K

1.9 K

Super Conducting
Link

Gaseous

Simplified connection

Others

SC magnet (NbTi)

SC magnet (Nb₃Sn)

Amorphous Coating

Machine configuration mirrored around Interaction Point (IP)

Breakdown of heat load by type

Determining refrigerator capacity

- Static
 - Heat-In leaks
- Resistive
- Beam Induced
 - Synchrotron radiation
 - Marginal for HL-LHC
 - Image current
 - Electron cloud
 - Beam Scattering
 - Only if degradation of vacuum
- Collision induced
- Radio frequency induced (Crab cavities)

Dynamic heat loads

Not determining

- Cooldown
- Magnet induced
 - Ramp-up / ramp-down
 - Magnet Quench
- Pulse induced

Heat load mechanisms

Static → **occurs at any time** with the same magnitude

Magnetic (AC losses) → occurs only during current **ramp-up** and **ramp-down**

Specific load 5.1 W/m

Magnetic length at cold → 31.1 m

Resistive → goes with the square of current intensity in splice

Splices resistance → 1 nΩ

Local powering current leads

Beam induced → occurs as long as the **beam is circulating**

Assumed linear with injection → 17 min

Beam dump assumed instantaneous

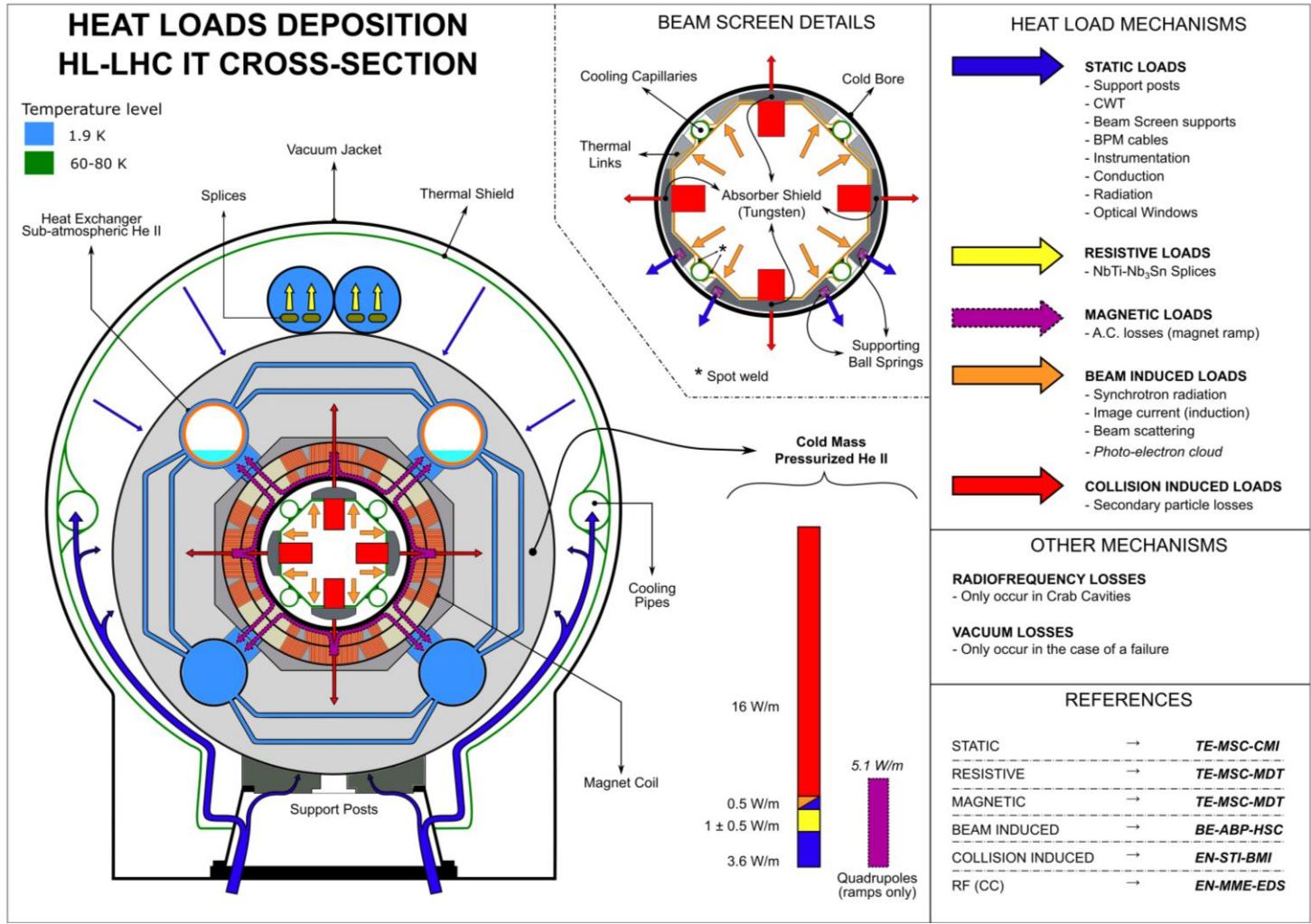
Collision induced → suddenly occurs when particles collide

Initial regime: instantaneous

Time to max collisions: tbd.

Hilumi heat deposition

Magnet schematic - cross view



Terminology and heat loads margins definition

Name & Definition

Static heat load: Q_{static}

Raw static heat load from calculation or measurement without contingency.

Dynamic heat load: $Q_{dynamic}$

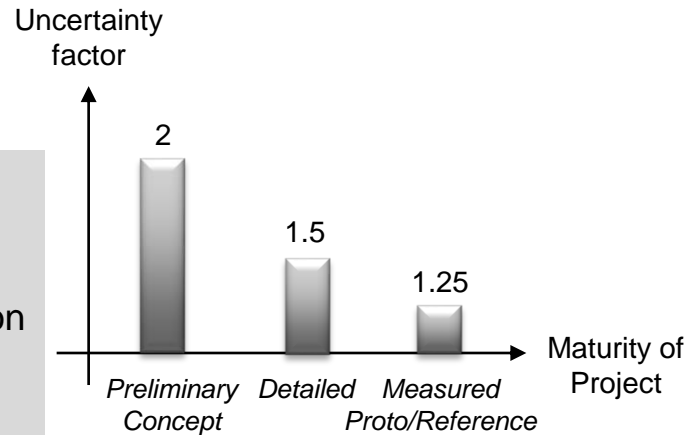
Raw dynamic heat load from calculation or simulation without contingency.

Design heat load: Q_{design}

Heat load including uncertainty and overcapacity margin

Installed local cooling capacity :

Capacity that is installed at the user interface



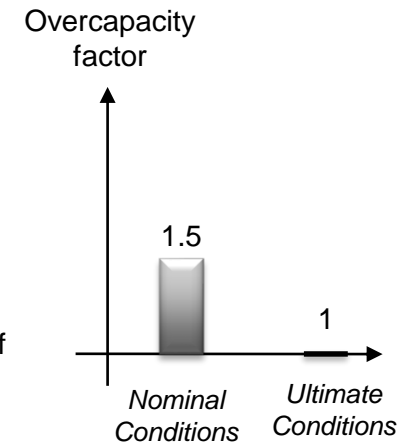
Uncertainty factor (F_{un})

Evolved during the project lifetime. On **static heat loads** only.

To cover:

- uncertainty in the design (material, installation...)
- Engineering change
- Tolerances
- Room for growth

Uncertainty factor evolves with maturity of design.



Overcapacity factor (F_{ov})

On static + dynamic.

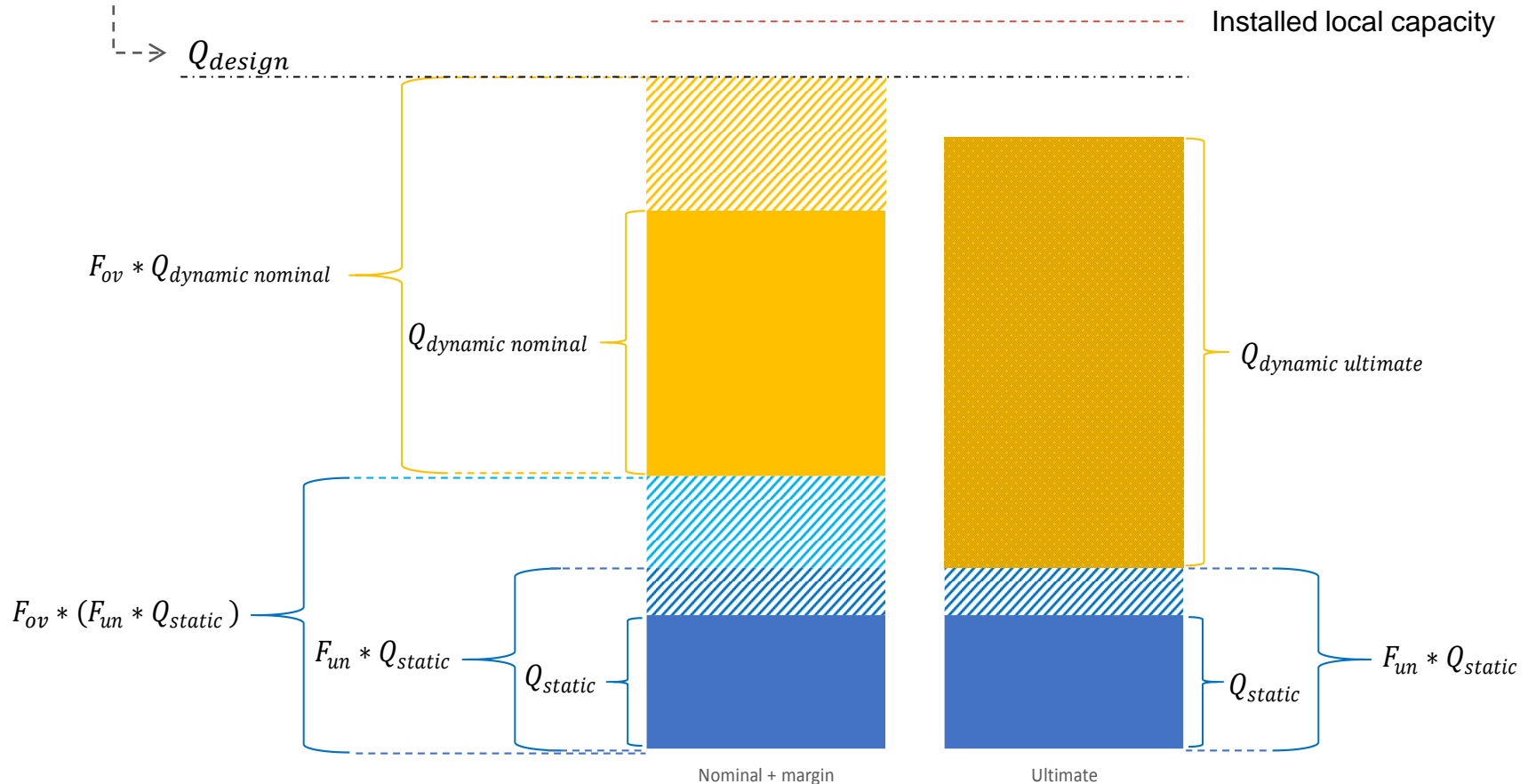
To ensure nominal performance by covering the risk; for example reduced performance, uncertainty due to modelling.

No margin taken on Ultimate Conditions.

Design heat load (Local)

General approach “*inspired from LHC project note 140*” :

$$Q_{design} = Max [F_{ov} * (F_{un} * Q_{static} + Q_{dynamic\ nominal}) ; F_{un} * Q_{static} + Q_{dynamic\ ultimate}]$$

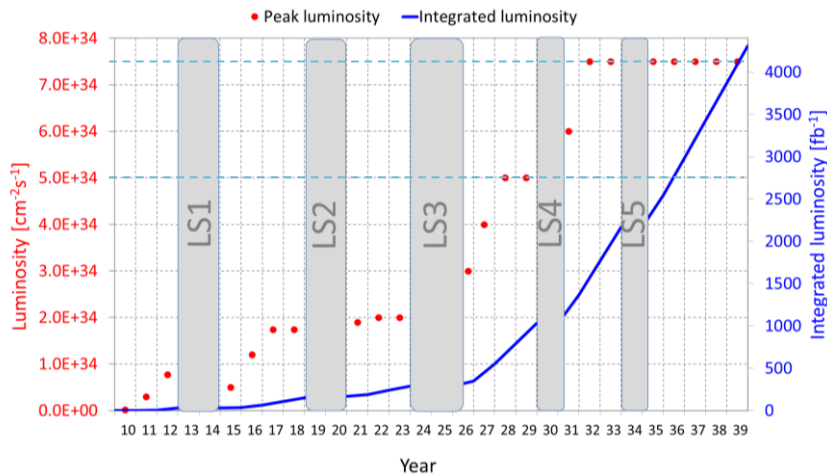


*graph not to scale

Dynamic Operational parameters

From Nominal to Ultimate dynamic heat loads

- **Nominal** conditions as well as **Ultimate Luminosity** and **Ultimate energy** are considered for the heat load review



	Luminosity	Energy
Nominal	5 L0	7 TeV
Ultimate	7.5 L0	7.5 TeV

* L0 = 10³⁴ Hz/cm²

- **Dynamic heat loads** are provided by **WP2** (beam induced heat loads) and by **WP10** (collision induced) for given beam parameters and Luminosity. → **Scaling factors** were required for **resistive and collision induced heat loads**.
- The change in beam induced heat loads between Ultimate and Nominal conditions is assumed negligible.

	Luminosity	Energy
Resistive	-	E ²
Collision	L	15% from 7 → 7.5 TeV

	Scaling factor
Resistive	1.15
Beam induced	1.00
Collision	1.72

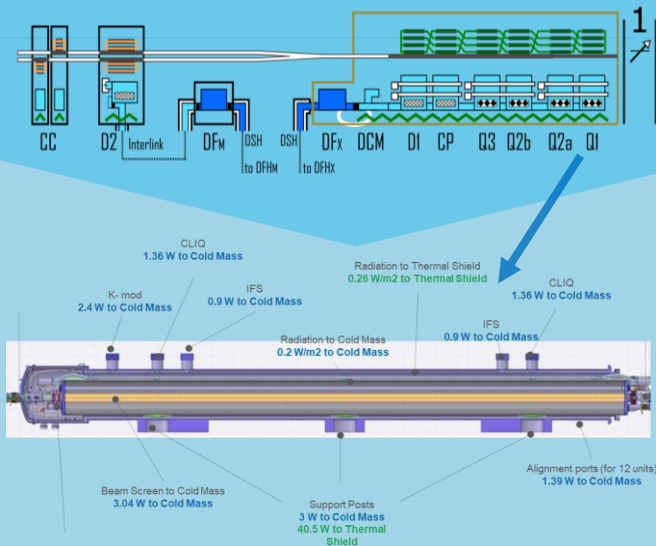
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Hilumi static heat load methodology

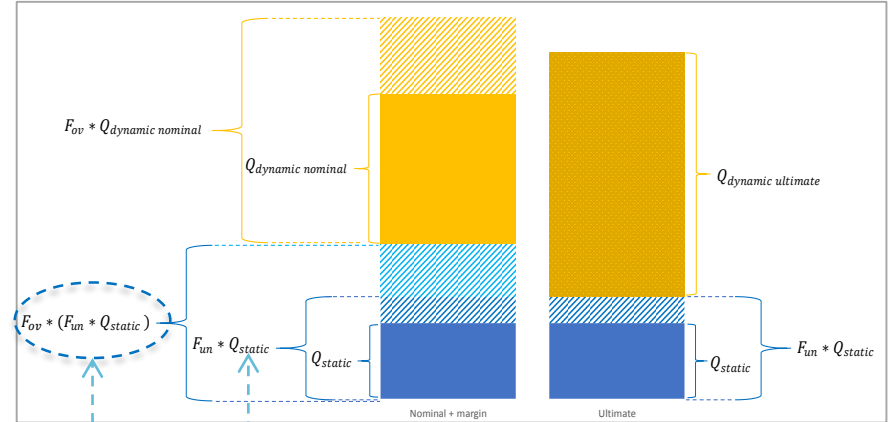
Q_{static} heat load

Approach for each Temperature level



K-mod				
Part	Block			
Function	Used for modulating the quadrupole gradients.			
Number of items	2 (4 modules, 2 per K-mod)			
CONTRACT				
Item	1 - description / 1 - name			
Department	BE-BA			
Label Reference	HL-LHC K-mod current feeders Crystal thermal performance test			
EDMS	2779955			
Revision	3			
Date	05/12/2019			
Property	Value			
Conductor cross section	10 mm ²			
Number of wires	2			
Length of conductor	2 m			
TEMPERATURES				
Operating temperature	1.9 K			
Warm	300 K			
Intercept	K			
No intercept implemented				
Powering	25 A			
Current				
HEAT LOAD COMPONENTS LAYOUT				
Date	Unit	Items	Item 2779955	Drawing Nr.
Conduction to 1.9 K	0.2 W	K		
Resistive load at 1.9 K	0.2 W	K		
HEAT LOAD DATA per unit				
Heat load 1.9 K	Value	Unit	Category	Final load status
Static	1.2 W	Measurement	Per K-mod	yes
Resistive	0.2 W	Measurement	Per K-mod	yes
Total	1.3 W	Measurement	Per K-mod	yes
			Beam induced	
			Current induced	

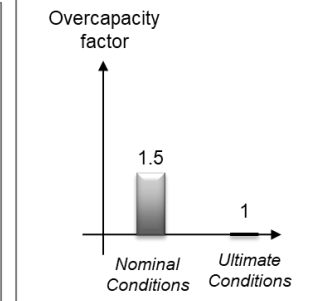
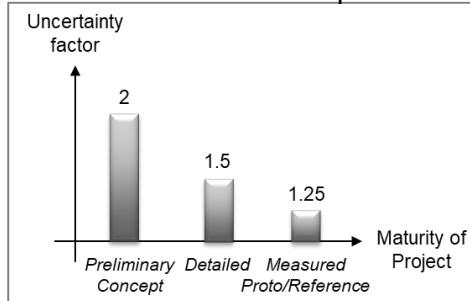
- Documentation
- Edms
- Indico
- Review
- Communication



Uncertainty factor according to the design maturity level

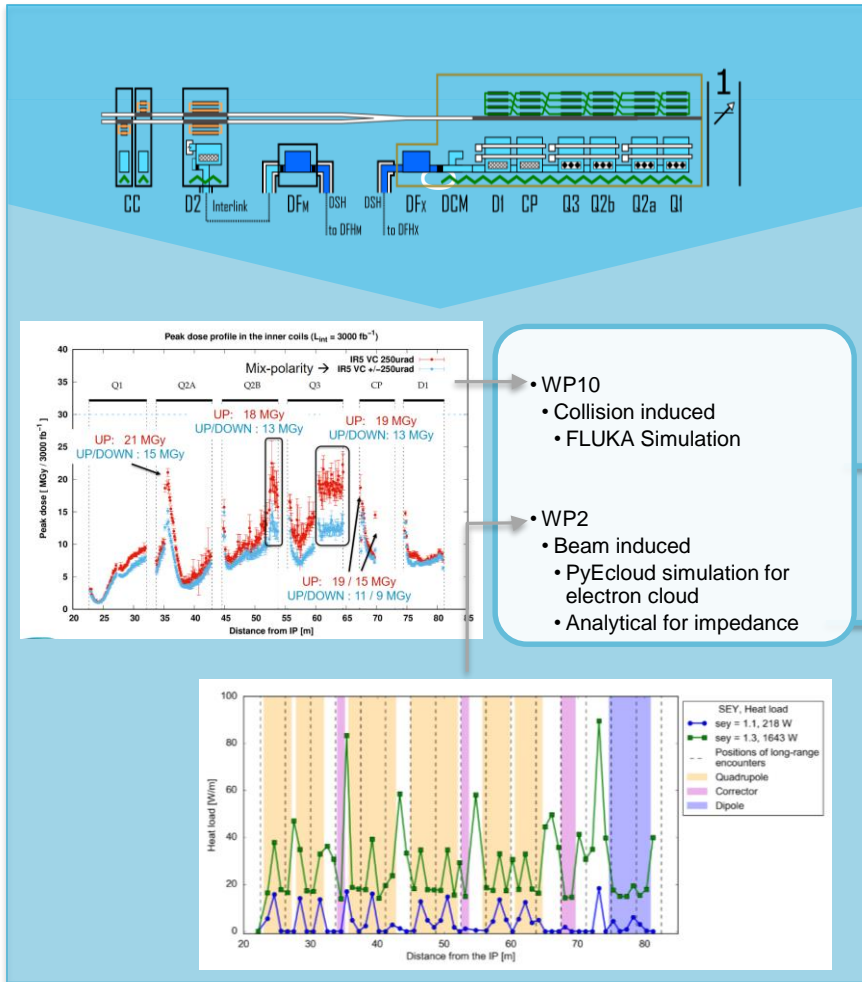
$F_{un} * Q_{static}$

$F_{ov} * (F_{un} * Q_{static})$

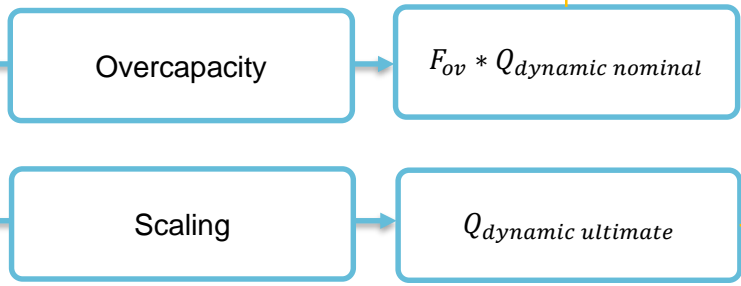
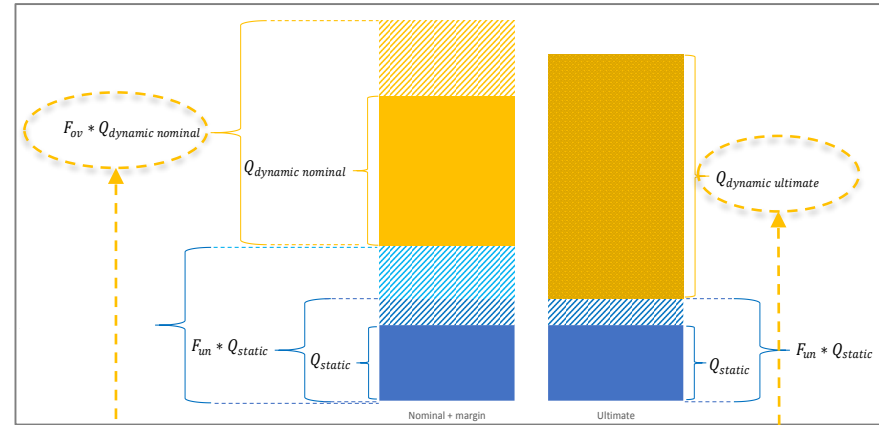


Hilumi dynamic heat load methodology

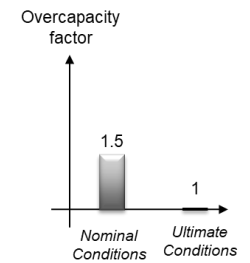
$Q_{dynamic}$ heat load



- WP10
 - Collision induced
 - FLUKA Simulation
- WP2
 - Beam induced
 - PyEcloud simulation for electron cloud
 - Analytical for impedance



	Scaling factor
Resistive	1.15
Beam induced	1.00
Collision	1.72

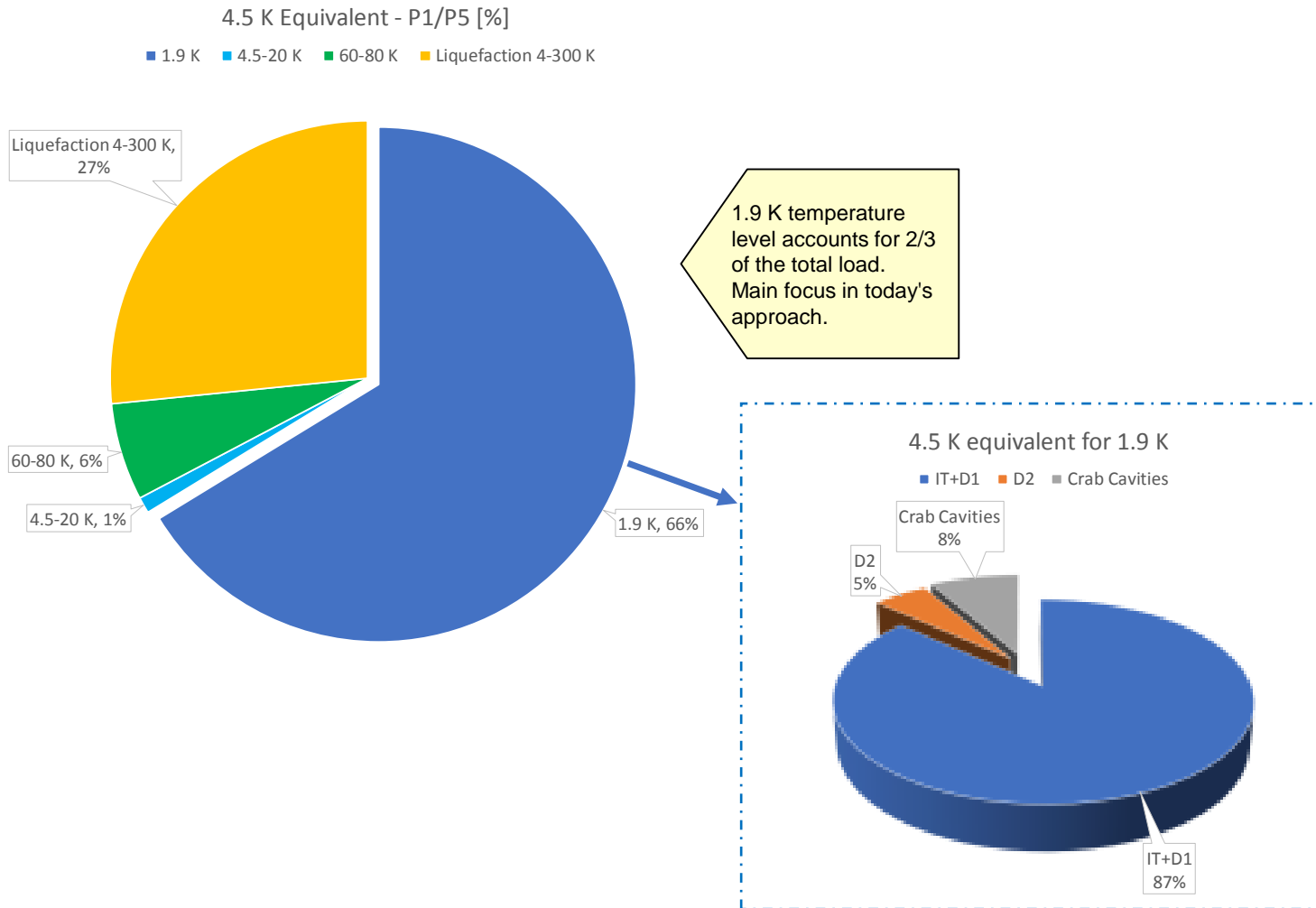


Conclusions

- Methodology to define the design heat loads for each user has been applied.
 - Static heat loads
 - Exhaustive breakdown approach performed
 - Dynamic heat loads
 - Beam/Collision induced heat loads provided by WP2/WP10 Simulations
 - Systematic approach to margin uncertainty/ overcapacity
- Solid repository compiling all inputs to validate heat loads and temperature levels for each user.

Global overview of heat loads (4.5 K equivalent)

In addition to the methodology an introduction to the users to come





Thanks for your time and answers

